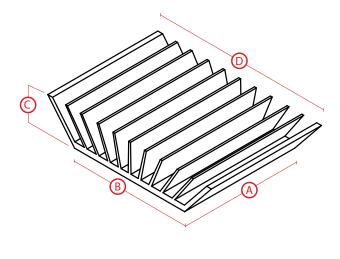


# High Performance ASIC Cooling Solutions w/Thermal Tape Attachment

### ATS PART # ATS-56005-C4-R0

#### **Features & Benefits**

- » maxiFLOW™ design features a low profile, spread fin array that maximizes surface area for more effective convection (air) cooling
- » Designed specifically for ASIC package and their unique cooling requirements





## **Thermal Performance**

\*Image above is for illustration purposes only.

AIR VELOCITY		THERMAL RESISTANCE		
FT/MIN	M/S	°C/W (UNDUCTED FLOW)	°C/W (DUCTED FLOW)	
200	1.0	2.8	1.65	
300	1.5	2.2		
400	2.0	1.6		
500	2.5	1.4		
600	3.0	1.2		
700	3.5	1.1		
800	4.0	1		

# **Product Details**

DIMENSION A	DIMENSION B	DIMENSION C	DIMENSION D	INTERFACE MATERIAL	FINISH
50 mm	45 mm	15 mm	64 mm	SAINT-GOBAIN NO TIM	BLACK-ANODIZED

#### NOTES

- Dimension C = heat sink height from bottom of the base to the top of the fin field.
- Thermal performance data are provided for reference only. Actual performance may vary by application.
- ATS reserves the right to update or change its products without notice to improve the design or performance.
- Contact ATS to learn about custom options available.



For more information, to find a distributor or to place an order, visit www.qats.com or call: 781.769.2800 (North America); +31 (0) 3569 84715 (Europe).